ADO ASSEMM MARER HANDLING

A SCHIM WAFER HANDLING

200 nm wafer Handine

Vacuum Hautine ay Stems RETULE HANDLING

CARRIER HANDLES



WAFER ALIGNER SERIES 150MM

NOTCH OR FLAT ALIGNMENT, AUTOMATED OR MANUAL



FACILITY REQUIREMENTS

100/240V AC - 50/60 Hz - 1.2 A

SPECIFICATIONS (MM)

AFA150:	L 285 x W 220 x H 192mm
MFA150:	L 226 x W 175 x H 128mm
ANA150:	L 285 x W 220 x H 192mm
MNA150:	L 226 x W 175 x H 128mm

DESCRIPTION

EMU Technologies series of Wafer Alignment products are clean-concept, affordable batch alignment tools designed for either notch or flat wafers.

True ESD Protection and use of specific materials for all wafer & carrier contact points ensure clean and safe alignment.

The Automated Aligners start alignment upon placement of the carrier. The desired post alignment angle can be selected on the user-friendly keypad.

The Manual Aligners are highly cost-effective and have been designed for simple and straight-forward use, without compromising wafer safety & particle contamination.





RECIF TECHNOLOGY

This tool has been designed under license from Recif Technologies using the same design principles, materials and kinematics as were used in the original equipment and wafer fabs around the world.